

March 2001 Revised May 2004

# **FIN1028**

# 3.3V LVDS 2-Bit High Speed Differential Receiver

# **General Description**

This dual receiver is designed for high speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The receiver translates LVDS levels, with a typical differential input threshold of 100 mV, to LVTTL signal levels. LVDS provides low EMI at ultra low power dissipation even at high frequencies. This device is ideal for high speed transfer of clock and data.

The FIN1028 can be paired with its companion driver, the FIN1027, or any other LVDS driver.

## **Features**

- Greater than 400Mbs data rate
- 3.3V power supply operation
- 0.4ns maximum differential pulse skew
- 2.5ns maximum propagation delay
- Low power dissipation
- Power-Off protection
- Fail safe protection for open-circuit, shorted and terminated conditions
- Meets or exceeds the TIA/EIA-644 LVDS standard
- Flow-through pinout simplifies PCB layout

# **Ordering Code:**

Order Number	Package Number	Package Description
FIN1028M (Note 1)	M08A	8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
FIN1028K8X (Preliminary)		8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide [TAPE and REEL]
FIN1028MPX (Preliminary)		8-Terminal Molded Leadless Package (MLP) Dual, MO-229, 2mm Square [TAPE and REEL]

Note 1: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

# **Pin Descriptions**

Pin Name	Description		
R <sub>OUT1</sub> , R <sub>OUT2</sub>	LVTTL Data Outputs		
R <sub>IN1+</sub> , R <sub>IN2+</sub>	Non-inverting LVDS Inputs		
R <sub>IN1-</sub> , R <sub>IN2-</sub>	Inverting LVDS Inputs		
V <sub>CC</sub>	Power Supply		
GND	Ground		

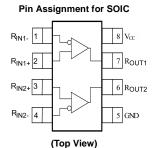
## **Function Table**

Input		Outputs
R <sub>IN+</sub>	R <sub>IN+</sub>	R <sub>OUT</sub>
L	Н	L
Н	L	Н
Fail Safe	Condition	Н

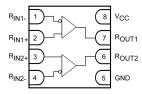
H = HIGH Logic Level L = LOW Logic Level

Fail Safe = Open, Shorted, Terminated

# **Connection Diagrams**



### Terminal Assignments for MLP



(Top Through View)

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DS500503

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# Absolute Maximum Ratings(Note 2)

Supply Voltage (V<sub>CC</sub>) -0.5V to +4.6V DC Input Voltage (R<sub>INx+</sub>, R<sub>INx-</sub>) -0.5V to +4.7VDC Output Voltage (R<sub>OUTx</sub>) -0.5V to +6V

DC Output Current (I<sub>O</sub>) 16 mA

Storage Temperature Range ( $T_{STG}$ )  $-65^{\circ}C$  to  $+150^{\circ}C$ 150°C

Max Junction Temperature (T<sub>J</sub>)

Lead Temperature (T<sub>I</sub>) (Soldering, 10 seconds)

260°C ESD (Human Body Model) ≥ 6500V

ESD (Machine Model) ≥ 300V

# **Recommended Operating Conditions**

Supply Voltage (V<sub>CC</sub>) 3.0V to 3.6V Input Voltage (V<sub>IN</sub>) 0 to  $V_{CC}$ 

Magnitude of Differential Voltage

100 mV to  $V_{CC}$  $(|V_{\mathsf{ID}}|)$ 

Common-mode Input Voltage

0.05V to 2.35V  $(V_{IC})$ 

Operating Temperature (T<sub>A</sub>) -40°C to +85°C

Note 2: The "Absolute Maximum Ratings": are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

## **DC Electrical Characteristics**

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	(Note 3)	Max	Units
V <sub>TH</sub>	Differential Input Threshold HIGH	See Figure 1 and Table 1			100	mV
$V_{TL}$	Differential Input Threshold LOW	See Figure 1 and Table 1	-100			mV
I <sub>IN</sub>	Input Current	$V_{IN} = 0V \text{ or } V_{CC}$			±20	μΑ
I <sub>I(OFF)</sub>	Power-OFF Input Current	$V_{CC} = 0V, V_{IN} = 0V \text{ or } 3.6V$			±20	μΑ
V <sub>OH</sub>	Output HIGH Voltage	$I_{OH} = -100 \mu A$	V <sub>CC</sub> −0.2			V
		$I_{OH} = -8 \text{ mA}$	2.4			v
V <sub>OL</sub>	Output LOW Voltage	$I_{OH} = 100 \mu A$			0.2	V
		I <sub>OL</sub> = 8 mA			0.5	1 "
V <sub>IK</sub>	Input Clamp Voltage	I <sub>IK</sub> = -18 mA	-1.5			V
I <sub>CC</sub>	Power Supply Current	$(R_{IN+} = 1V \text{ and } R_{IN-} = 1.4V) \text{ or }$			9	mA
		$(R_{IN+} = 1.4V \text{ and } R_{IN-} = 1V)$			9	IIIA
C <sub>IN</sub>	Input Capacitance			4		pF
C <sub>OUT</sub>	Output Capacitance			6		pF

Note 3: All typical values are at  $T_A = 25^{\circ}C$  and with  $V_{CC} = 3.3V$ .

## **AC Electrical Characteristics**

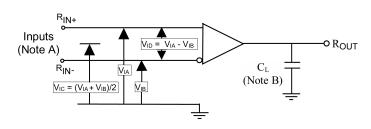
Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 4)	Max	Units
t <sub>PLH</sub>	Differential Propagation Delay LOW-to-HIGH		0.9		2.5	ns
t <sub>PHL</sub>	Differential Propagation Delay HIGH-to-LOW		0.9		2.5	ns
t <sub>TLH</sub>	Output Rise Time (20% to 80%)	$ V_{ID}  = 400 \text{ mV}, C_L = 10 \text{ pF},$		0.5		ns
t <sub>THL</sub>	Output Fall Time (80% to 20%)	See Figure 1 and Figure 2		0.5		ns
t <sub>SK(P)</sub>	Pulse Skew  t <sub>PLH</sub> - t <sub>PHL</sub>				0.4	ns
t <sub>SK(LH)</sub> , t <sub>SK(HL)</sub>	Channel-to-Channel Skew (Note 5)				0.3	ns
t <sub>SK(PP)</sub>	Part-to-Part Skew (Note 6)				1.0	ns

Note 4: All typical values are at  $T_A = 25^{\circ}C$  and with  $V_{CC} = 3.3V$ .

 $\textbf{Note 5:} \ t_{SK(LH)}, \ t_{SK(HL)} \ \text{is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same directions of the same direction of the same direct$ 

Note 6: t<sub>SK(PP)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.



Note A: All input pulses have frequency = 10 MHz,  $t_{R}$  or  $t_{F}$  = 1  $\,\text{ns}$ 

Note B:  $\mathbf{C}_{\mathsf{L}}$  includes all probe and fixture capacitances

FIGURE 1. Differential Driver Propagation Delay and Transition Time Test Circuit

TABLE 1. Receiver Minimum and Maximum Input Threshold Test Voltages

Applied '	Voltages (V)	Resulting Differential Input Voltage (mV)	Resulting Common Mode Input Voltage (V)	
V <sub>IA</sub>	V <sub>IB</sub>	V <sub>ID</sub>	V <sub>IC</sub>	
1.25	1.15	100	1.2	
1.15	1.25	-100	1.2	
2.4	2.3	100	2.35	
2.3	2.4	-100	2.35	
0.1	0	100	0.05	
0	0.1	-100	0.05	
1.5	0.9	600	1.2	
0.9	1.5	-600	1.2	
2.4	1.8	600	2.1	
1.8	2.4	-600	2.1	
0.6	0	600	0.3	
0	0.6	-600	0.3	

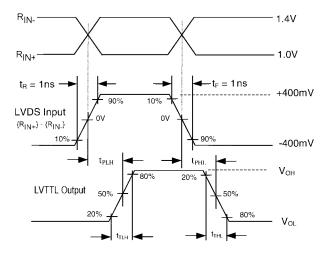
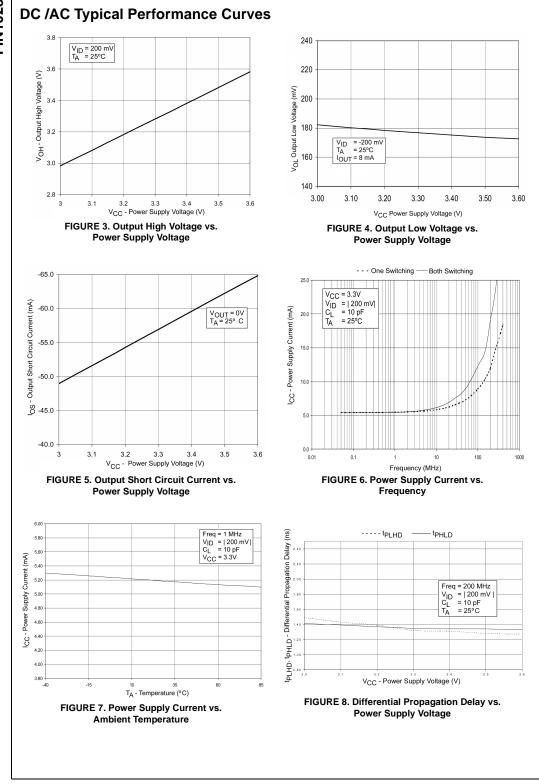
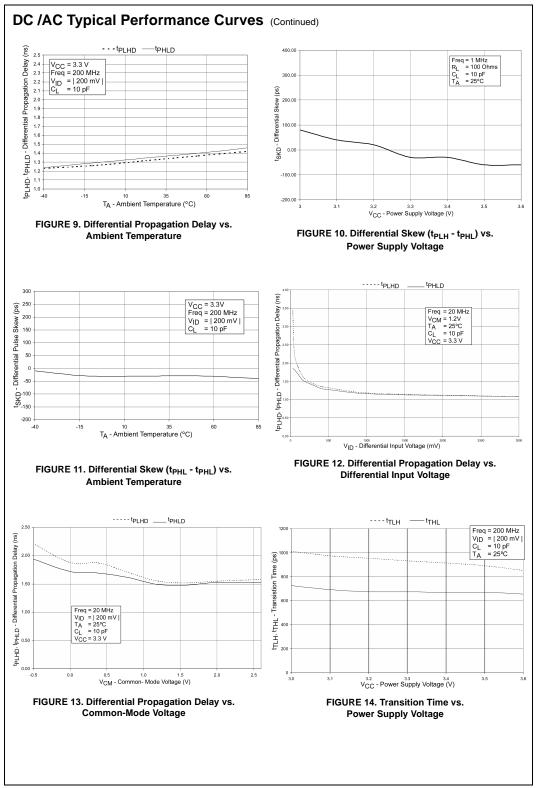
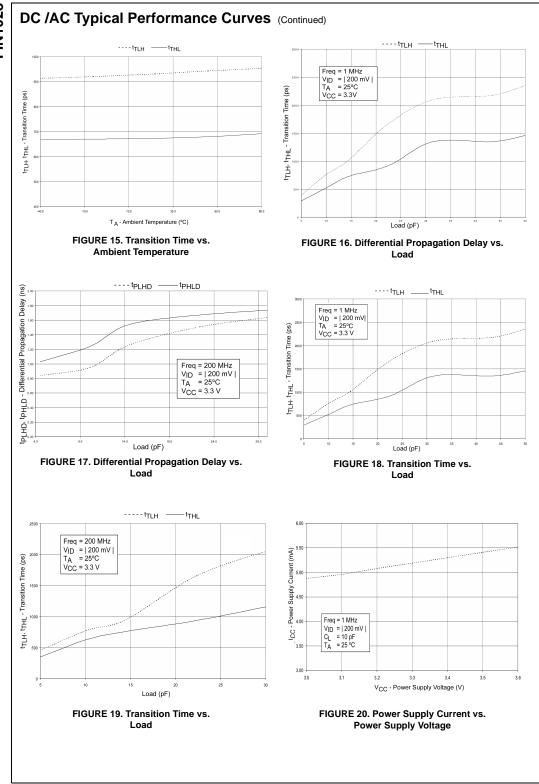


FIGURE 2. AC Waveforms



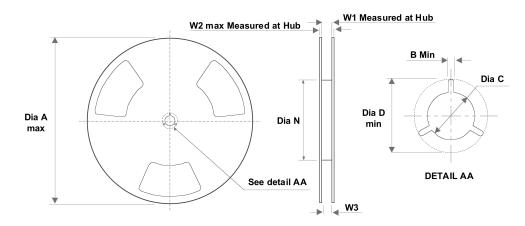




#### **Tape and Reel Specification** TAPE FORMAT for MLP T<sub>C</sub> Package Ko P<sub>1</sub> Ро $P_2$ Wc $D_1$ $\pm 0.05$ Min ±0.1 ±0.1 TYP TYP ±0/05 ±0.005 TYP ±0.10 ±0.10 ±0.1 2.30 2.30 1.55 1.0 1.75 3.5 8.0 2.0 0.06 5.3 MLP Embossed Tape Dimensions (Dimensions are in millimeters) W

Ao

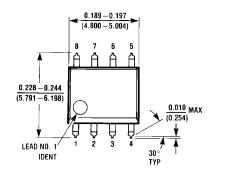
## **REEL DIMENSIONS** (millimeters)

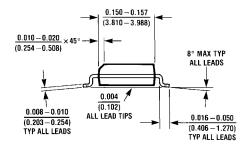


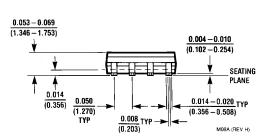
Tape Width	Dia A Max	Dim B Min	Dia C +0.5/-0.2	Dia D Min	Dim N Min	Dim W1 +2/-0	Dim W2 Max	Dim W3 (LSL - USL)
8 mm	330	1.5	13	20.2	178	8.4	14.4	7.9 ~ 10.4

User Direction of Feed

# Physical Dimensions inches (millimeters) unless otherwise noted

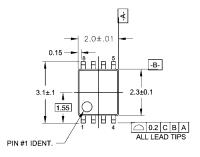


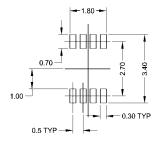




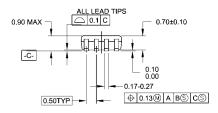
8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M08A

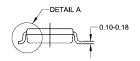
# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





### LAND PATTERN RECOMMENDATION





# 0.4 TYP GAGE PLANE 0.12 SEATING PLANE 0.20-0.35-

## NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187 B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

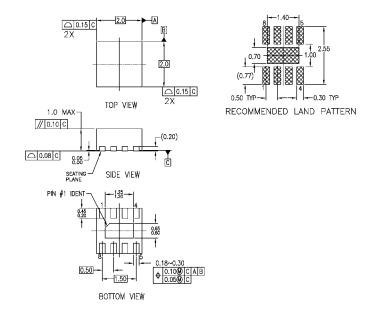
DETAIL A

## MAB08AREVC

8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide Package Number MAB08A

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# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-229, VARIATION VCCD-3, DATED 11/2001
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

# MLP08CrevB

8-Terminal Molded Leadless Package (MLP) Dual, MO-229, 2mm Square
Package Number MLP08C
(Preliminary)

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